

WHAT IS CLAIMED IS:

- 1           1.       A current-in-plane (CIP) GMR sensor, comprising:  
2           a GMR sensor stack;  
3           a spacer layer formed over a free-layer of the GMR sensor stack; and  
4           an in-stack biasing layer disposed over the spacer.
  
- 1           2.       The CIP GMR sensor of claim 1, wherein the in-stack biasing layer  
2       comprises materials selected from the group consisting of NiFe, CoFe, NiFeCr, NiFe<sub>x</sub>  
3       and CoFe<sub>x</sub>.
  
- 1           3.       The CIP GMR sensor of claim 1 further comprising lead layers formed on  
2       either side of the GMR sensor stack.
  
- 1           4.       The CIP GMR sensor of claim 3, wherein the lead layers comprises a layer  
2       of Rhodium disposed adjacent to the GMR sensor stack, a Tantalum layer formed over  
3       the layer of Rhodium and a layer of Platinum-Manganese formed over the layer of  
4       Tantalum.
  
- 1           5.       The CIP GMR sensor of claim 4, wherein the layer of Platinum-  
2       Manganese is formed adjacent a portion of the in-stack bias layer.

1           6.       The CIP GMR sensor of claim 3, wherein the in-stack biasing layer  
2       comprises a bias layer formed only over the spacer and a coupling layer formed over the  
3       bias layer and the layer of Platinum-Manganese.

1           7.       The CIP GMR sensor of claim 6, wherein the bias layers and coupling  
2       layer each comprise a material selected from the group consisting of NiFe, CoFe, NiFeCr,  
3       NiFe<sub>x</sub> and CoFe<sub>x</sub>.

1           8.       The CIP GMR sensor of claim 1 further comprising a cap layer formed  
2       over the in-stack bias layer.

1           9.       A magnetic storage system, comprising:  
2               a magnetic storage medium having a plurality of tracks for recording of data; and  
3               a current-in-plane (CIP) GMR sensor maintained in a closely spaced position  
4       relative to the magnetic storage medium during relative motion between the magnetic  
5       transducer and the magnetic storage medium, the CIP GMR sensor further comprising:  
6               a GMR sensor stack;  
7               a spacer layer formed over a free-layer of the GMR sensor stack; and  
8               an in-stack biasing layer disposed over the spacer.

1           10.      The magnetic storage of claim 9, wherein the in-stack biasing layer  
2       comprises materials selected from the group consisting of NiFe, CoFe, NiFeCr, NiFe<sub>x</sub>  
3       and CoFe<sub>x</sub>.

1           11.     The magnetic storage of claim 9 further comprising lead layers formed on  
2     either side of the GMR sensor stack.

1           12.     The magnetic storage of claim 11, wherein the lead layers comprises a  
2     layer of Rhodium disposed adjacent to the GMR sensor stack, a Tantalum layer formed  
3     over the layer of Rhodium and a layer of Platinum-Manganese formed over the layer of  
4     Tantalum.

1           13.     The magnetic storage of claim 12, wherein the layer of Platinum-  
2     Manganese is formed adjacent a portion of the in-stack bias layer.

1           14.     The magnetic storage of claim 11, wherein the in-stack biasing layer  
2     comprises a bias layer formed only over the spacer and a coupling layer formed over the  
3     bias layer and the layer of Platinum-Manganese.

1           15.     The magnetic storage of claim 9, wherein the bias layer and the coupling  
2     layer each comprise a material selected from the group consisting of NiFe, CoFe, NiFeCr,  
3     NiFe<sub>x</sub> and CoFe<sub>x</sub>.

1           16.     The magnetic storage of claim 9 further comprising a cap layer formed  
2     over the in-stack bias layer.

1           17.     A method for providing a current-in-plane (CIP) GMR sensor with an  
2 improved in-stack bias layer with a thinner sensor stack, comprising;  
3           forming a thin spin valve stack;  
4           forming a spacer over the spin valve stack;  
5           forming lead layers in a passive region outside the track;  
6           forming an in-stack bias layer over the spacer for biasing a free-layer of the spin  
7 valve stack; and  
8           forming a cap over the bias layer.

1           18.     The method of claim 17, wherein forming the lead layers further  
2 comprises forming a layer of Rhodium adjacent to the GMR sensor stack, forming a  
3 Tantalum layer over the layer of Rhodium and forming a layer of Platinum-Manganese  
4 over the layer of Tantalum.

1           19.     The method of claim 18, wherein the forming of the layer of Platinum-  
2 Manganese further comprises forming the layer of Platinum-Manganese adjacent a  
3 portion of the in-stack bias layer.

1           20.     The method of claim 18, wherein the in-stack bias layer comprises a bias  
2 layer formed only over the spacer and a coupling layer formed over the bias layer and the  
3 layer of Platinum-Manganese.

1           21.     The method of claim 17, wherein the forming of the bias layer and the  
2     coupling layer each further comprises using a material selected from the group consisting  
3     of NiFe, CoFe, NiFeCr, NiFe<sub>x</sub> and CoFe<sub>x</sub>.